

Description

YB7002 charge high voltage photoflash capacitors quickly and efficiently. Designed for use in digital and film cameras, these devices use flyback topology to achieve efficiencies up to four times better than the competing flash modules. A unique peak inductor current control mechanism maintains current-limited mode transformer operation throughout the entire charge cycle, eliminating the high inrush current often found in flash modules.

YB7002 output voltage sensing scheme monitors the flyback voltage to directly regulate the output voltage. This feature allows the capacitor to be held at a fully charged state without excessive power consumption. Adjustable refresh time is fully controllable by the user with a resistor. The DONE pin signals that the capacitor is full charged.

Features

- Charge Any Size Photoflash Capacitor
- Support Operation from Two AA Cells or Any Supply from 1.8V to 16V
- Use Standard Transformers
- No High Voltage Zener Diode Required
- Built in 40V Output Switch
- Adjustable Output Voltage
- Adjustable Peak Switch Current
- Automatic Refresh with Adjustable Timer
- Charge Complete Indicator
- Small 10-Lead MSOP Packages

Applications

- Digital Camera Flash unit
- Film Camera Flash Unit
- High Voltage Power Supplies

Typical Application Circuit

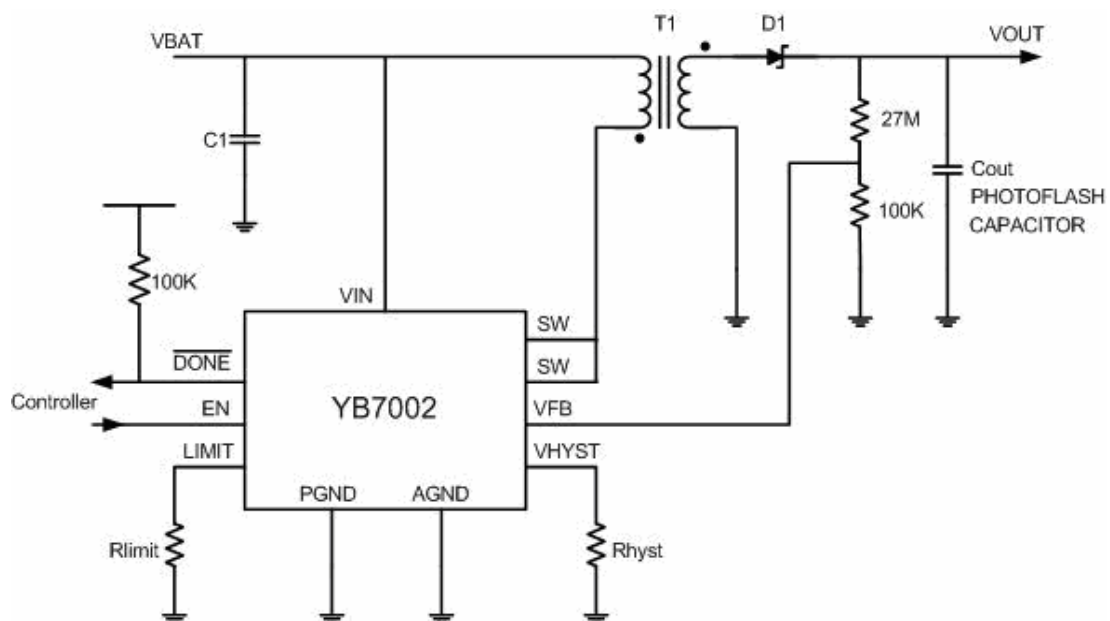


Figure 1: Typical Application Circuit

Pin Configuration

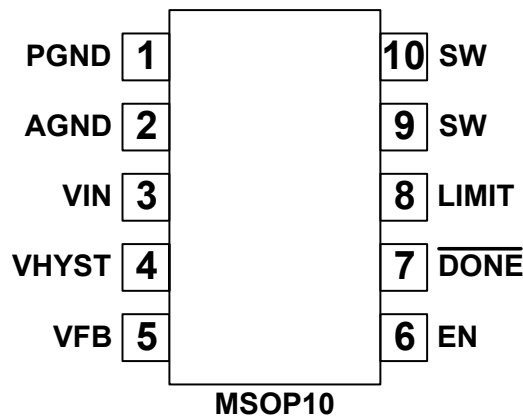


Figure 2: Pin Configuration

Pin Description

Table 1

Pin	NAME	Description
1	PGND	Power Ground, tie solidly to system ground of the board.
2	AGND	Analog Ground, tie solidly to system ground of the board.
3	VIN	Input supply pin. Must be locally connected to bypassed capacitor to eliminate noise.
4	VHYST	Connecting a resistor R_{HYST} from V_{HYST} to ground will set the refresh time. A 13.5KΩ resistor and R_{HYST} form a divider circuit to restart the charging cycle once V_{FB} is dropping below V_{HYST} .
5	VFB	A resistor divider from V_{OUT} to ground enables the system to sense V_{OUT} voltage and determine the charging and recharging cycles.
6	EN	Device Enable, a 1.8V or above will turn on the IC. Below 0.4V will put the chip in shut down mode.
7	DONE	Once V_{OUT} voltage reaches above the designated value, DONE pin will be pulled low to indicate charging is completed.
8	LIMIT	Tie a resistor R_{limit} from Limit to ground will adjust the value of the peak Switch pin current. An 11μA current going through R_{limit} sets up the peak voltage the sense node can reach (see the block diagram).
9, 10	SW	They connect to the collector of the power NPN device.

Ordering Information

Order Number	Package Type	Supplied As	Package Marking
YB7002	MSOP10	2500 units Tape & Reel	Please contact sales representative

Absolute Maximum Ratings

V _{IN}	16V
SW Voltage	40V
DONE	16V
Current into DONE pin	1mA
Maximum Junction Temp, T _J (note).....	125°C
Storage Temperature Range	-65°C to 50°C
Lead Temperature (Soldering 10 sec).....	300°C
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C
Power Dissipation, P _D @ T _A =25°C.....	467mW

Recommended Operating Conditions

Operating Temperature	-40°C to 85°C
Supply Voltage.....	2V to 16V
Maximum SW Voltage	40V

Thermal Resistance

θ_{JA}	74.18°C /W
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Electrical Characteristics

Table 2 (V_{IN} = 3.3V, T_A=25°C, unless otherwise noted.)

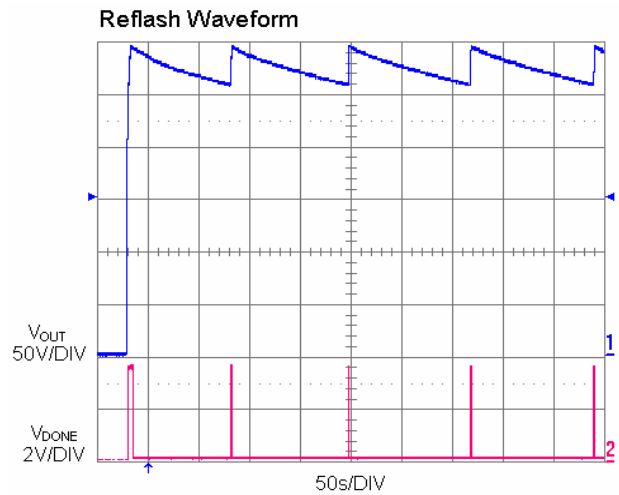
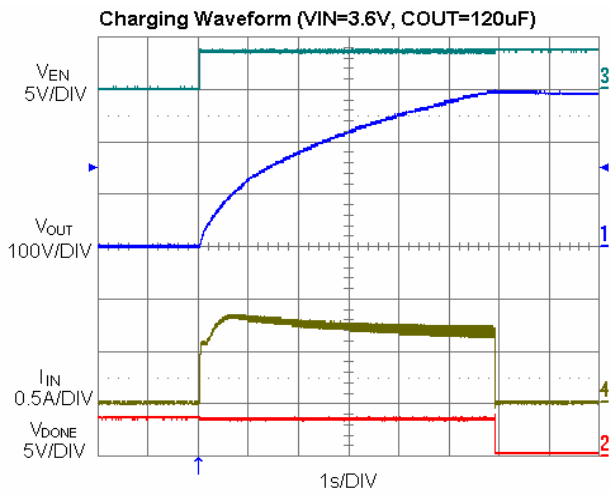
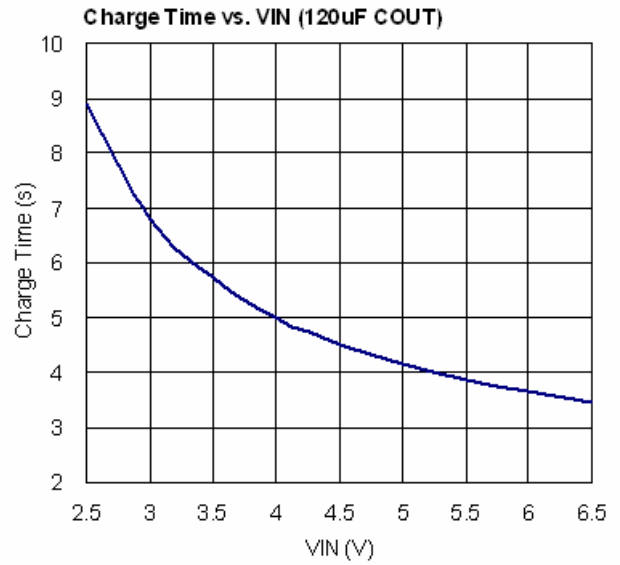
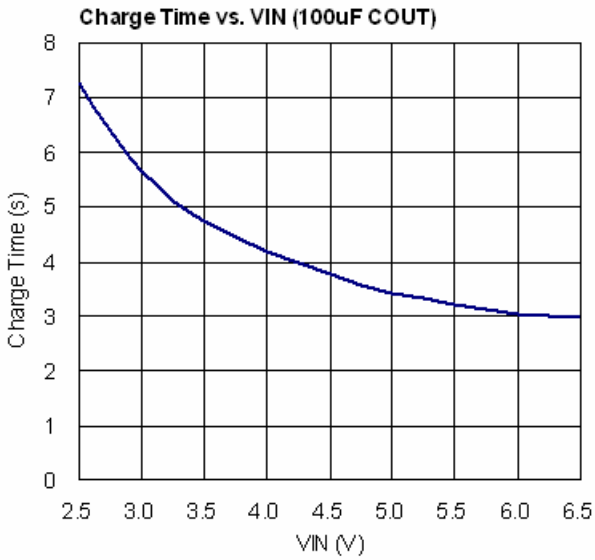
Description	Symbol	Test Conditions	MIN	TYP	MAX	Units
Input Voltage Range	V _{IN}		2		16	V
Quiescent Current	I _Q	V _{FB} = 1.5V			400	μA
Shutdown Current	I _{SD}	EN = 0V			10	μA
FB Threshold Voltage	V _{FB}		1.21	1.23	1.25	V
FB Pin Bias Current	I _{FB}	V _{FB} = 1.23V			250	nA
Primary Site Peak Current Limit	I _{PEAK,PRI}	R _{LIMIT} = 26KΩ	1.1	1.2	1.3	A
SW Leakage Current	I _{LKG}	V _{SW} = 40V, V _{FB} = 1.5V		1	10	μA
Switch Off Time	T _{OFF}			1000		ns
Switch Saturation Voltage	V _{CE,SAT}	I _{SW} = 300mA		220	340	mV
SW On/Off Hysteresis ratio		R _{HYST} = 150KΩ		8		%
EN Pin Input Voltage High	V _{IH}		1.8			V
EN Pin Input Voltage Low	V _{IL}				0.4	V
EN Pin Bias Current	I _{EN}	V _{EN} = 3V		4.5	15	μA
		V _{EN} = 0V		0.01	1	
DONE Pin Output Signal High	V _{OH}	100KΩ at V _{IN} to DONE		3.3		V
DONE Pin Output Signal Low	V _{OL}	33μA into DONE pin		100	200	mV

Note :

Absolute maximum ratings are limits beyond which damage to the device may occur.

The maximum allowable power dissipation is a function of maximum junction temperature, T_{J(MAX)}, the junction to ambient thermal resistance, θ_{JA} , and the ambient temperature. The maximum allowable power dissipation at any ambient temperature is calculated using: P_{D(MAX)} = [T_{J(MAX)} - T_A] / θ_{JA} . Exceeding the maximum allowable power dissipation will cause excessive die temperature. All limits at temperature extremes are guaranteed via correlation using standard statistical methods.

Typical Performance Characteristics



Function Block

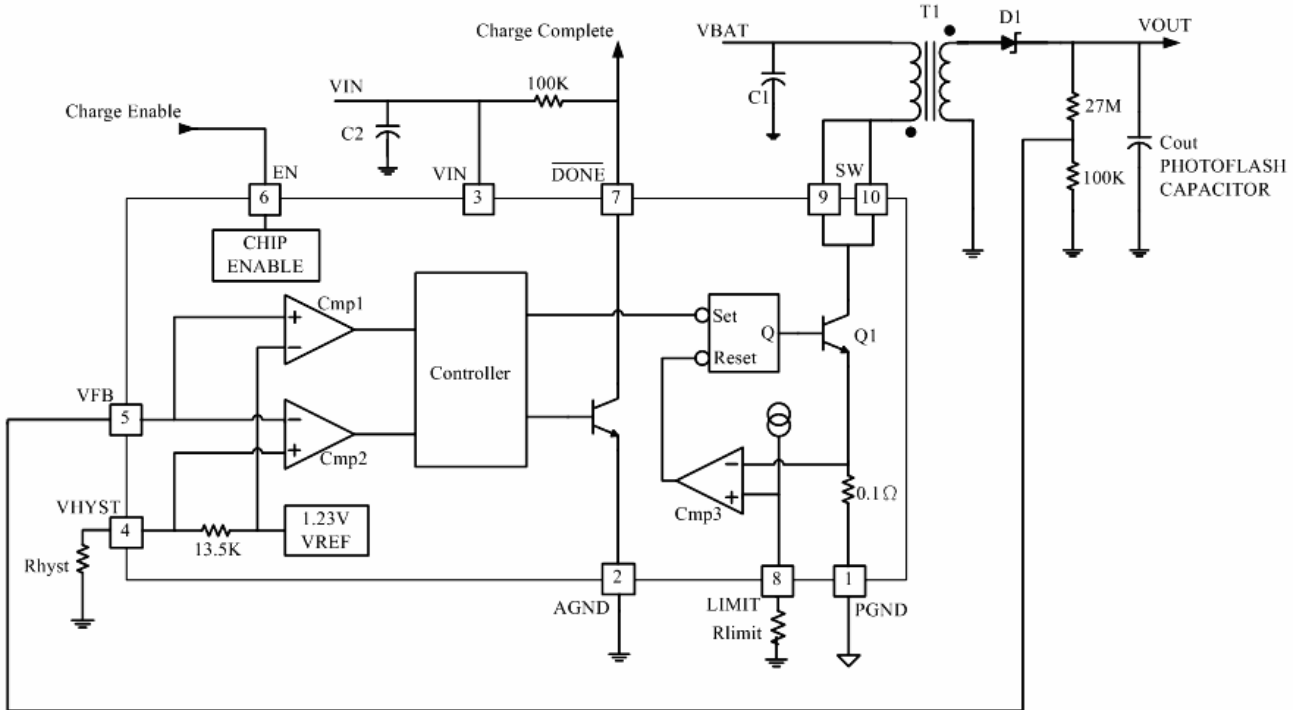


Figure 3: Function Block

Functional Description

YB7002 employs the peak-current-limit scheme to control the charging of the inductor current. Once the inductor current reaches the preset value determined by the Limit Pin, output power NPN is shut off and the primary side energy is delivered to the secondary side capacitor. The discharging time is set to be about 1 μ s. Once the discharge cycle is completed, the power NPN is on again. If the secondary side output voltage has not yet reached the designated value, the inductor current will be charged up to the preset value again. This charging and discharging sequence will repeat itself until the output capacitor voltage gets to the designated value and triggers the on-off latch to hold off the power NPN regardless the inductor current value.

As the power switch is off, output capacitor starts to drop slowly due to its own leakage and the resistor divider. When V_{FB} voltage is below V_{HYST} , on-off latch turns on the power NPN again and the charging cycle is enabled.

User is able to use resistors to set Limit Pin value and V voltage. An 11 μ A current source is coming out of the IC and going through the limit resistor R to ground. Limit pin voltage determines the peak inductor current. The higher the Limit pin voltage, the larger the peak inductor current would be. **USER MUST BE CAREFUL WITH THE THERMAL EFFECT GENERATED DURING THE CAPACITOR CHARGING CYCLE.** To reduce the thermal temperature, user can lower the resistor R value to reduce the peak inductor current.

Application Information

Hysteresis voltage is setup by connecting a resistor R_{HYST} from V_{HYST} to ground. A resistor divider of 13.5K Ω (internal resistor) and R_{HYST} from bandgap voltage will determine hysteresis voltage. Once V_{FB} drops below V_{HYST} voltage, charging cycle is activated again. To calculate the refresh time, consider the followings:

$$C_{OUT} \cdot \frac{\partial V_{OUT}}{\partial t} + \frac{V_{OUT}}{R1 + R2} + I_{COUT,LEAKAGE} = 0$$

As the capacitor leakage current is a function of output voltage, it can be considered to be constant within the tiny range of voltage from V_{OUT} to $V_{HYST} \cdot \frac{R1 + R2}{R2}$, where R1 and R2 are the resistor divider at the secondary side output.

By solving the above equation, we can find the time it takes for capacitor voltage to drop from V_{OUT} to $V_{HYST} \cdot \frac{R1 + R2}{R2}$.

For the convenience of the user, two tables have been setup for reference. Table 3 is for Limit Pin while Table 4 is for V_{HYST} . Please check the tables to pick the resistor values for peak primary inductor current and recharge voltage.

Table 3

R_{LIMIT}	10 K Ω	15 K Ω	20 K Ω
Peak Current	0.8A	1A	1.2A

Table 4 ($V_{OUT}=300V$)

R_{HYST}	Hysteresis ratio	Recharge Voltage
436.5 K Ω	3%	291V
211.5 K Ω	6%	282V
136.5 K Ω	9%	273V
99 K Ω	12%	264V

Once capacitor reaches the designated voltage, DONE pin will be pulled low to indicate the completion of charging process. When output voltage drops below secondary capacitance, the series resistance will improve system efficiency and performance.

Primary side inductance will affect the charging time. Higher primary side inductance will raise the average discharging current into the output capacitance, resulting a smaller charging time. Yet, thermal effect will become adversely affecting the system. So always pay attention to the amount of dissipated $V_{HYST} \cdot \frac{R1 + R2}{R2}$, DONE is released to signal the re-start of charging process.

User always has the freedom to shut off the operation of the chip by pulling the ENABLE pin lower than 0.4V. Also to activate the IC, ENABLE pin NEED needs to be above 1.8V. In shutdown mode, the chip is only drawing about 2 μ A current.

Component Selection

The rectifying diode must be of low capacitance type while being able to withstand peak reverse voltage and heavy forward current.

The peak reverse voltage is:

$$V_{R,PEAK} = V_{OUT} - (-N \cdot V_{BAT}) = V_{OUT} + N \cdot V_{BAT}$$

$$I_{SEC,MAX} = \frac{I_{PRI,MAX}}{N}$$

As $I_{PRI,MAX}$ is being set by R_{LIMIT} , its value can reach as high as 1.5A.

Since the switching voltage across the rectifying diode is very large, any parasitic capacitance across the diode will translate to huge loss for the system. Moreover, it will slow down the transition of the Switch pin, inducing further loss of efficiency.

Input Capacitor

Even though the chip is not drawing much current, still a good decoupling capacitor is needed for V_{IN} pin.

It is very important to have a solid V_{BAT} voltage. A low ESR ceramic capacitor is recommended.

Transformer

A number of issues must be considered before selecting a transformer.

Turn ratio N, primary inductance, primary side series resistance, transformer leakage inductance, secondary capacitance and series resistance, transformer efficiency are the main considerations when choosing a transformer.

$$V_{SWITCH} = V_{BAT} + \frac{V_{OUT} + V_D}{N}$$

Care must be exercised so that V_{SWITCH} will not exceed the maximum voltage breakdown voltage of 40V. Minimizing primary side series resistance, transformer

leakage inductance, secondary capacitance and series resistance will improve system efficiency and performance.

Primary side inductance will affect the charging time. Higher primary side inductance will raise the average discharging current into the output capacitance, resulting a smaller charging time. Yet, thermal effect will become adversely affecting the system. So always pay attention to the amount of dissipated power.

Thermal Consideration:

When YB7002 is set to handle high switch current will result in internal power dissipation generating heat. For thermal improvement can be made by use of vias to connects the part and dissipate heat to an internal ground plane.

Placing vias under the exposed thermal pad of package can be lowered significant. Using larger traces and more copper on the top site of board can also further help. With careful PCB layout it is possible to reduce the thermal effect.

Always beware the amount of power dissipated during the charging process.

Too high the temperature built up inside the IC will slow the charging cycle and lengthen the charging time, further worsen the thermal condition of the IC. To resolve the thermal built up issue, reduce R_{LIMIT} which lower the peak switch current.

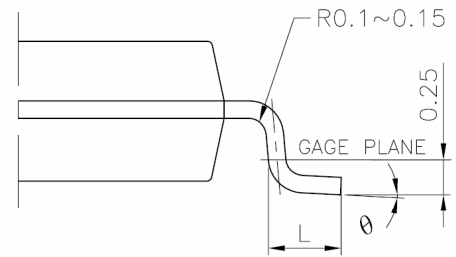
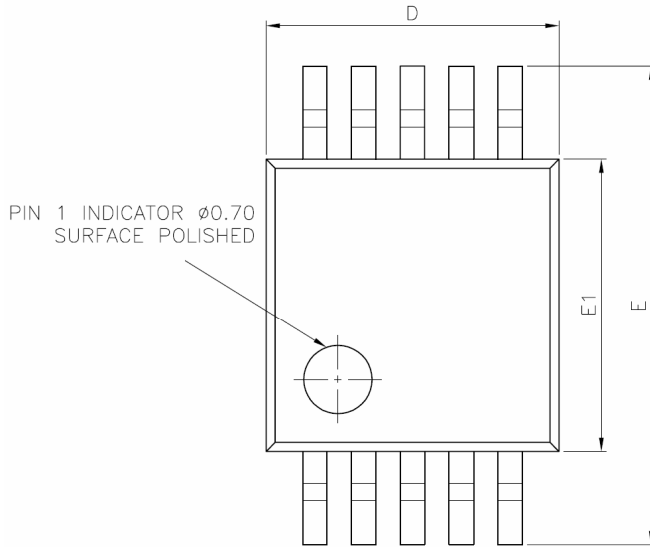
Layout consideration

The input bypass capacitor C2 must be placed close to the IC. This will reduce copper trace resistance which effect input voltage ripple of the IC.

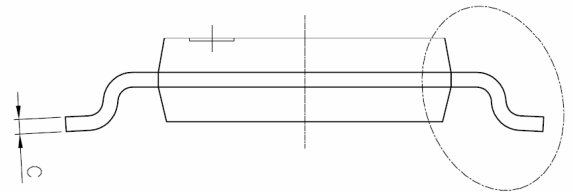
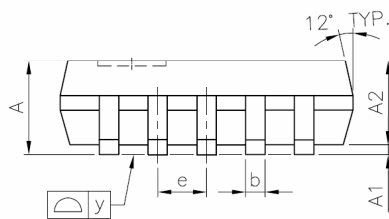
The capacitor, C1, should also be placed close to the transformer T1. The copper trace connections for the C1, T1, and the YB7002 should be kept short as possible to eliminate over-voltage condition on SW pin due to leakage inductance of T1.

For improved thermal performance can increase the top side copper to dissipate heat from the package. Numerous vias from the ground connection to the internal ground plane located underneath the package will help.

Package Information (MSOP10)



DETAIL A



DETAIL A

SYMBOLS	DIMENSIONS IN MILLIMETERS		
	MIN	NOM	MAX
A	—	—	1.10
A1	0.05	—	0.15
A2	0.75	0.86	0.95
b	0.17	0.20	0.27
C	0.08	0.15	0.23
D	2.90	3.00	3.10
E	4.80	4.90	5.00
E1	2.90	3.00	3.10
e	—	0.50	—
L	0.40	0.53	0.80
y	—	—	0.076
θ	0°	3°	8°

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